

N-Channel 100-V (D-S) MOSFET

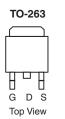
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
100	0.010 at V _{GS} = 10 V	100			
	0.023 at V _{GS} = 4.5 V	85			

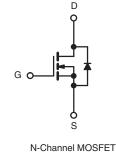
FEATURES

• TrenchFET[®] Power MOSFET



175 °C Maximum Junction Temperature
Compliant to RoHS Directive 2002/95/EC





ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Symbol Parameter Limit Unit VDS **Drain-Source Voltage** 100 ٧ Gate-Source Voltage V_{GS} ± 20 $T_C = 25 \ ^{\circ}C$ 100 Continuous Drain Current (T_J = 150 °C) I_D T_C = 125 °C 75 ^a А I_{DM} 300 **Pulsed Drain Current** Avalanche Current I_{AS} 75 L = 0.1 mH mJ Single Pulse Avalanche Energy^b E_{AS} 280 $T_{C} = 25 \ ^{\circ}C \ (TO-220AB \ and \ TO-263)$ 250^c P_D W Maximum Power Dissipation^b T_A = 25 °C (TO-263)^d 3.75 T_J, T_{stg} °C Operating Junction and Storage Temperature Range - 55 to 175

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W		
Junction-to-Ambient	Free Air (TO-220AB)		62.5			
Junction-to-Case		R _{thJC}	0.6			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-		•				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100				
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μΑ	
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V _{GS} = 10 V, I _D = 30 A		0.010		Ω	
		V _{GS} = 4.5 V, I _D = 20 A		0.023			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		0.020			
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}, \text{ T}_{J} = 175 ^{\circ}\text{C}$		0.030			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b			•				
Input Capacitance	C _{iss}			6550		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$	-	665			
Reverse Transfer Capacitance	C _{rss}			265			
Total Gate Charge ^c	Qg			105	160	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		17			
Gate-Drain Charge ^c	Q _{gd}			23			
Turn-On Delay Time ^c	t _{d(on)}			12	25		
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 0.6 Ω		90	135	ns	
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong$ 85 A, V_{GEN} = 10 V, R_g = 2.5 Ω		55	85		
Fall Time ^c	t _f			130	195		
Source-Drain Diode Ratings and Cha	racteristics T _C :	= 25 °C ^b					
Continuous Current	ا _S				85	^	
Pulsed Current	I _{SM}				240	A	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			85	140	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dI/dt = 100 A/μs		4.5	7	Α	
Reverse Recovery Charge	Q _{rr}	1		0.17	0.35	μC	

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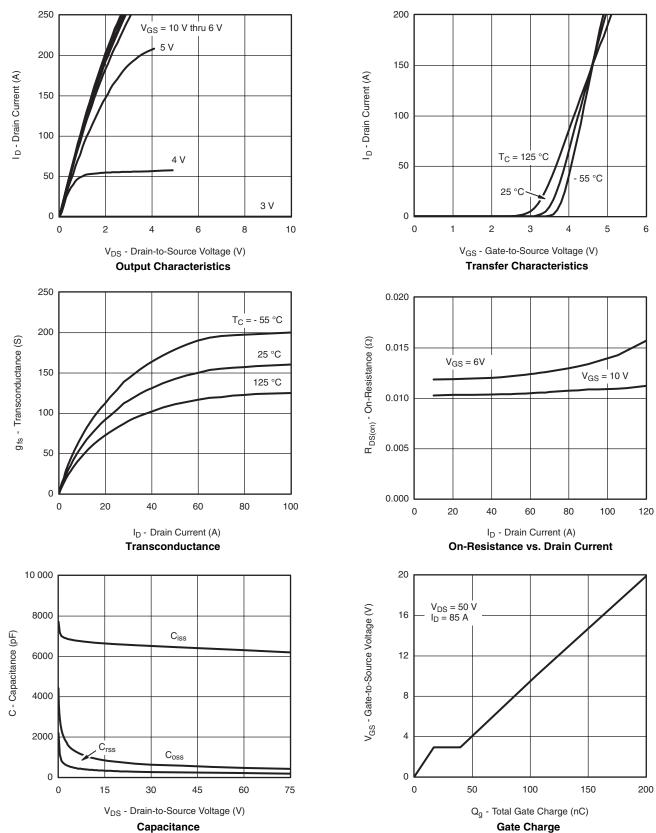
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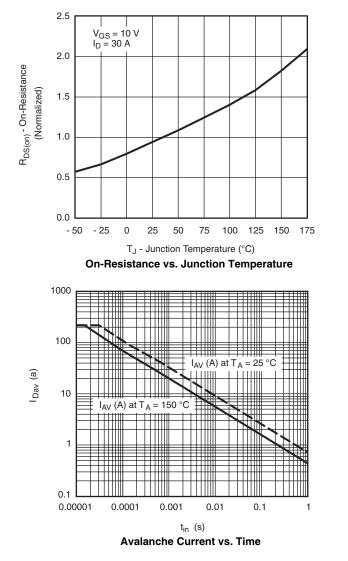
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted

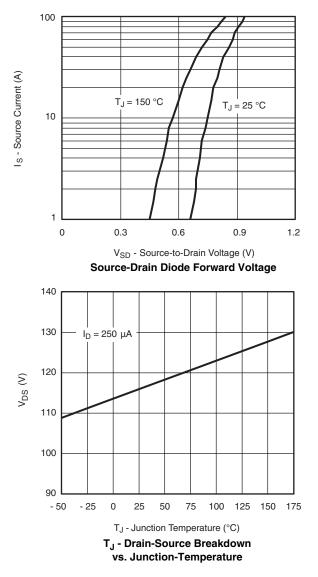


服务热线:400-655-8788



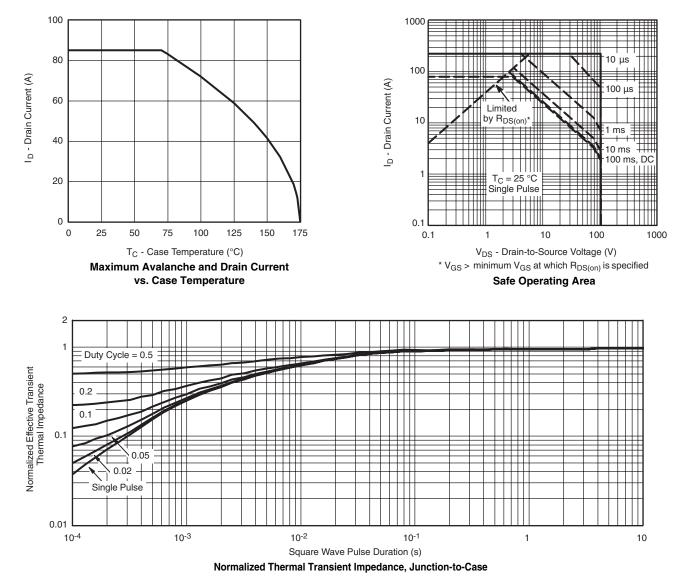
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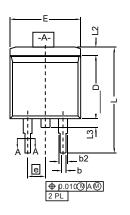


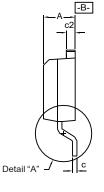
THERMAL RATINGS

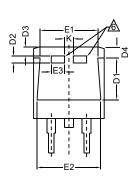




TO-263 (D²PAK): 3-LEAD

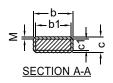








DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
b1		0.020	0.035	0.508	0.889	
b2		0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
	Thick lead	0.023	0.028	0.584	0.711	
<u>1</u>	Thin lead	0.013	0.017	0.330	0.431	
c1	Thick lead	0.023	0.027	0.584	0.685	
c2		0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
D1		0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
E1		0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100 BSC		2.54 BSC		
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
			0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.



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